

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Morio GAKU et al.

Serial No. [NEW]

: Attn: Application Branch

Filed December 28, 2001

: Attorney Docket No. 2001-1911

METHOD OF MAKING THROUGH HOLE
WITH LASER, COPPER-CLAD LAMINATE
SUITABLE FOR MAKING HOLE, AND
AUXILIARY MATERIAL FOR MAKING
HOLE

(Rule 1.53(b) Divisional of Serial No.
09/271,897, Filed March 18, 1999)

THE COMMISSIONER IS AUTHORIZED
TO CHARGE ANY DEFICIENCY IN THE
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ACCOUNT NO. 23-0975.

2/14
P.G.
3-15-02

PRELIMINARY AMENDMENT

Assistant Commissioner for Patents,
Washington, DC 20231

Sir:

In the interest of compact prosecution, please amend the present application as follows:

IN THE SPECIFICATION:

OK Please insert the following paragraph before line 5 on page 1 of the specification:

This is a divisional of Serial No. 09/271,897, filed March 18, 1999.

*Please replace the paragraph beginning at line 14 on page 4 of the specification with
the following rewritten paragraph:*

According to the present invention, there is also provided a method of making penetration holes according to the above, wherein coatings or sheets of an organic substance containing 3 to 97 % by volume of at least one powder selected from the group consisting of a metal compound powder having a melting point of at least 900°C and a bond energy of at least 300 KJ/mol, a

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